

11-19-1998



Docket No. JCLA2532

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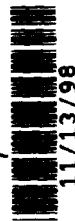
## RECORDATION FORM COVER SHEET

U.S. Department of Commerce  
Patent and Trademark Office

## PATENTS ONLY

jc549 U.S. PTO

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11/13/98

To the Honorable Assistant Commissioner for Patents: Please record the attached  
original documents or copy thereof.

1. Name of conveying party(ies):

Shih-Ching Chen  
Neng-Hsing Shen2. Name/address of receiving  
Party(ies):

United Semiconductor Corp.

3. Nature of conveyance: ☒ Assignment☐ Merger ☐ Security Agreement ☐ Other☐ Change of Name ☐ ReassignmentNo 3, Li-Hsin Rd. II, Science-Based  
Industrial Park, Hsinchu,  
Taiwan, R.O.C.

4. Date(s) of execution: October 26, 1998;

Add'l names of receiving parties

Attached? ☐ Yes ☒ No

5. Application number(s) or patent number(s):

**If this documents is being filed together with a new application, the  
execution date of the application is October 26, 1998**

A. Patent Application No. (s)

B. Patent No. ( s)

Additional numbers attached ? ☐ Yes ☒ No6. Name and address of party to whom  
correspondence concerning document  
should be mailed:J.C. Patents, Inc.  
1340 Reynolds Ave., Suite 114  
Irvine, CA 92614  
(949) 660-07617. Total No. of applications and patents  
involved:

ONE(1)

8. Total fee (37 CFR §3.41): \$40.00

☒ Enclosed☐ Charge to Acct. No.9. Total number of pages, including  
cover sheet, attachments and document 3.

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10. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true  
and correct and any attached copy is a true copy of the original document.Jiawei Huang  
Name of Person Signing

  
Signature


  
Date

40.00 CP

Provisional Registration No. P-43.330

11/19/1998 JWA/TMS 0000027 09191327

-01 FC-501

PATENT

REEL: 9585 FRAME: 0263

11-13-98  
 MSJ

# ASSIGNMENT

WHEREAS,

1. Shih-Ching Chen

2. Neng-Hsing Shen

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **METHOD OF FORMING HEMISPHERICAL GRAIN POLYSILICON OVER LOWER ELECTRODE CAPACITOR**

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS, United Semiconductor Corp.

of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

# ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Shih - Ching Chen October 26, 1998

Sole or First Joint Inventor: Shih-Ching Chen

Signature: Neng - Hsing Shen October 26, 1998

Second Joint Inventor (if any): Neng-Hsing Shen